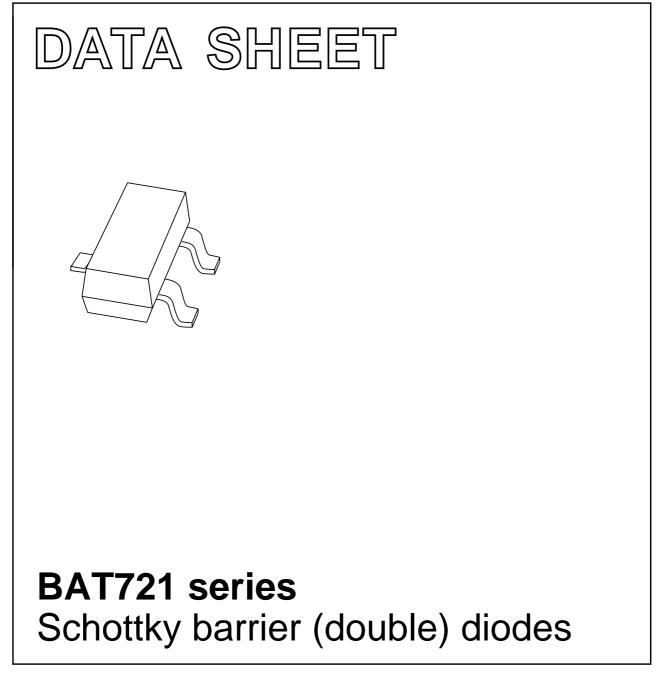


| Order code | Manufacturer code | Description |
|------------|-------------------|-------------|
| 47-2924 | n/a | n/a |
| 47-2926 | n/a | n/a |
| 47-2928 | n/a | n/a |
| 47-2930 | n/a | n/a |
| 47-2932 | n/a | n/a |
| 47-2934 | n/a | n/a |
| 47-2936 | n/a | n/a |
| 47-2938 | n/a | n/a |

The enclosed information is believed to be correct, Information may change 'without notice' due to product improvement. Users should ensure that the product is suitable for their use. E. & O. E.

Technical: 01206 835555 Tech@rapidelec.co.uk

DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 2001 Oct 12 2004 Mar 15



BAT721 series

FEATURES

- Ultra high switching speed
- · Low forward voltage
- · Guard ring protected
- Small plastic SMD package.

APPLICATIONS

- · Ultra high-speed switching
- · Voltage clamping
- Protection circuits.

DESCRIPTION

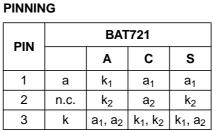
Planar Schottky barrier diodes encapsulated in a SOT23 small plastic SMD package. Single diodes and double diodes with different pinning are available.

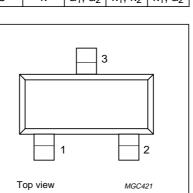
MARKING

| TYPE NUMBER | MARKING CODE ⁽¹⁾ |
|-------------|--------------------------------|
| BAT721 | L7* |
| BAT721A | L8* |
| BAT721C | L9* |
| BAT721S | L0* |

Note

- 1. * = p : Made in Hong Kong.
 - * = t : Made in Malaysia.
 - * = W: Made in China.

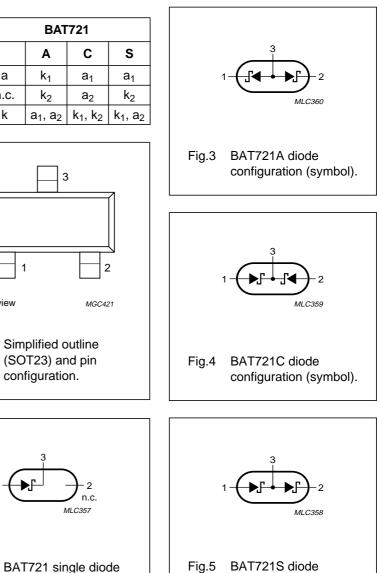




Simplified outline Fig.1 (SOT23) and pin configuration.

configuration (symbol).

Fig.2



configuration (symbol).

BAT721 series

ORDERING INFORMATION

| TYPE NUMBER | PACKAGE | | | |
|-------------|---------|--|---------|--|
| | NAME | DESCRIPTION | VERSION | |
| BAT721 | _ | plastic surface mounted package; 3 leads | SOT23 | |
| BAT721A | | | | |
| BAT721C | | | | |
| BAT721S | | | | |

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------------|--|------|------|------|
| V _R | continuous reverse voltage | | _ | 40 | V |
| l _F | continuous forward current | | _ | 200 | mA |
| I _{FSM} | non-repetitive peak forward current | t _p = 8.3 ms half sinewave; JEDEC method | _ | 1 | А |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | _ | 125 | °C |

ELECTRICAL CHARACTERISTICS

 $T_j = 25 \ ^{\circ}C$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | TYP. | MAX. | UNIT |
|----------------|----------------------------|---|------|------|------|
| V _F | continuous forward voltage | see Fig.6 | | | |
| | | I _F = 10 mA | - | 300 | mV |
| | | I _F = 100 mA | _ | 420 | mV |
| | | I _F = 200 mA | _ | 550 | mV |
| I _R | continuous reverse current | V _R = 30 V; see Fig.7 | _ | 15 | μA |
| | | $V_R = 30 \text{ V}; \text{ T}_j = 100 ^\circ\text{C}; \text{ see Fig.7}$ | _ | 3 | mA |
| C _d | diode capacitance | $f = 1 MHz; V_R = 0 V; see Fig.8$ | 40 | 50 | pF |

Note

1. Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02$.

THERMAL CHARACTERISTICS

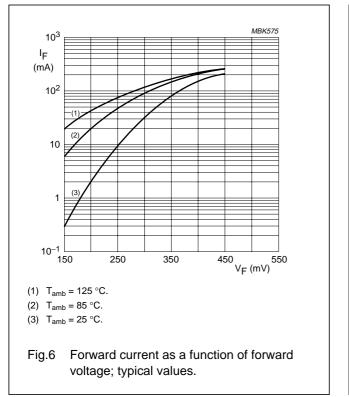
| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|----------------------|---|------------|-------|------|
| R _{th(j-a)} | thermal resistance from junction to ambient | note 1 | 500 | K/W |

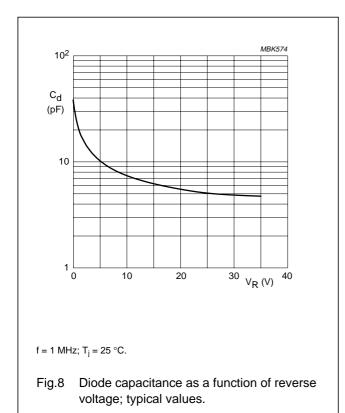
Note

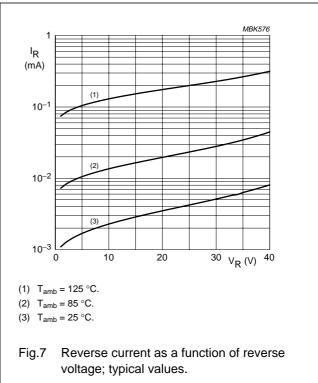
1. Refer to SOT23 standard mounting conditions.

BAT721 series

GRAPHICAL DATA

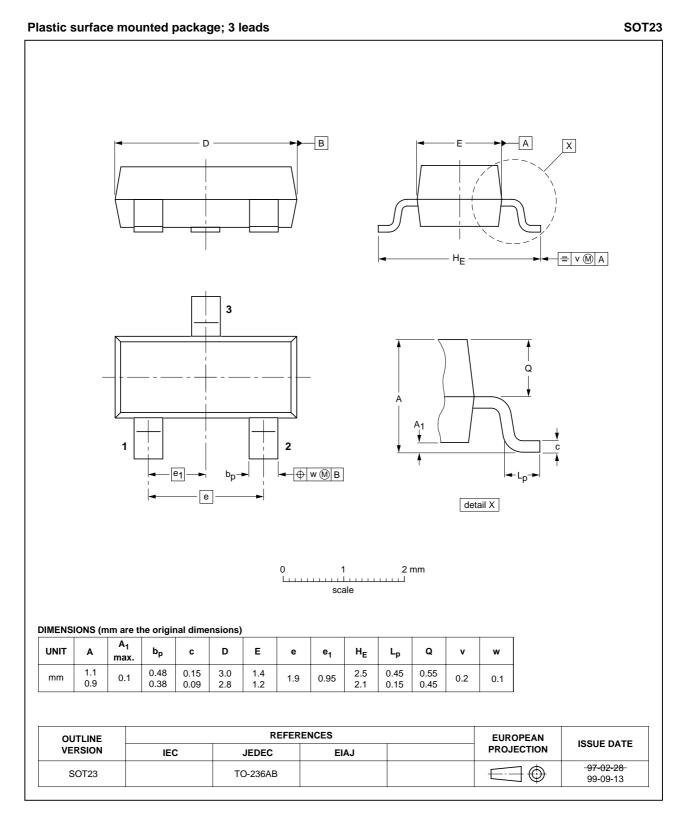






BAT721 series

PACKAGE OUTLINE



BAT721 series

DATA SHEET STATUS

| LEVEL | DATA SHEET STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾⁽³⁾ | DEFINITION |
|-------|-------------------------------------|-------------------------------------|--|
| I | Objective data | Development | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice. |
| 11 | Preliminary data | Qualification | This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product. |
| | Product data | Production | This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN). |

Notes

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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